Supporting Information

Adaptable sublattice stabilized high-entropy materials with superior

thermoelectric performance

Haotian Gao^a, Kunpeng Zhao^{a,b*}, Hexige Wuliji^{a*}, Min Zhu^c, Beibei Xu^c, He Lin^d, Liting Fei^d, Hongyao Zhang^d, Zhengyang Zhou^e, Jingdan Lei^a, Heyang Chen^a, Shun Wan^b, Tian-Ran Wei^{a,b}, and Xun Shi^{a,e*}

A: Lattice thermal conductivity calculations

The lattice thermal conductivity is calculated by subtracting the carrier contribution κ_{e} and bipolar contribution $\kappa_{bipolar}$ from the total κ , i.e. $\kappa_{L} = \kappa - \kappa_{e} - \kappa_{bipolar}$, where κ_{L} is lattice thermal conductivity, κ is measured total thermal conductivity, κ_{e} is electrical thermal conductivity, and $\kappa_{bipolar}$ is bipolar thermal conductivity. The carrier thermal conductivity can be determined by the Wiedemann-Franz law: $\kappa_{e}=L_{0}\sigma T$, where T is absolute temperature, σ is experimental electrical conductivity and L is the Lorenz factor. The simple two-band model proposed by Simon¹, i.e. one parabolic conduction band and one parabolic valence band, is used to calculate the bipolar contribution $\kappa_{bipolar}$. The Lorenz factor L can be estimated by Equations S1–S2¹:

$$S = \mathsf{m}\frac{k_B}{e} \left(\frac{(\lambda + 2)F_{\lambda + 1}(\eta)}{(\lambda + 1)F_{\lambda}(\eta)} - \eta \right)$$
(S1)

$$L = \left(\frac{k_{\rm B}}{e}\right)^2 \left\{ \frac{(\lambda+3)F_{\lambda+2}(\eta)}{(\lambda+1)F_{\lambda}(\eta)} - \left[\frac{(\lambda+2)F_{\lambda+1}(\eta)}{(\lambda+1)F_{\lambda}(\eta)}\right]^2 \right\}$$
(S2)

where *e* is elementary charge, $k_{\rm B}$ is Boltzmann constant, *S* is experimental Seebeck coefficient, η is reduced Fermi level, λ is scattering parameter, and $F_{\lambda}(\eta)$ is Fermi integrate defined as $F_{\lambda}(\eta) = \int_{0}^{\infty} \frac{x^{\lambda}}{1 + e^{x - \eta}} dx$.

The room temperature reduced Fermi level is derived from both the carrier

concentration and Seebeck coefficient on the basis of single band approximation. Assuming that the intrinsic carrier n_0 is negligible and external doping is fully excitation, external dopant N_D is equal to be experimental carrier concentration at room temperature. Therefore, the electron concentration, hole concentration and reduced Fermi level can be solved by Equations S3–S5¹:

$$n = p_0 + N_{\rm D} \tag{S3}$$

$$n = 4\pi \left(\frac{2m_e^* k_{\rm B}T}{h^2}\right)^{3/2} F_{\lambda}(\eta)$$
(S4)

$$p = 4\pi \left(\frac{2m_{h}^{*}k_{\rm B}T}{h^{2}}\right)^{3/2} F_{\lambda}(-\eta - E_{\rm g})$$
(S5)

where m_e^* is electron effective mass, m_h^* is hole effective mass and E_g is band gap.

The electron Seebeck coefficient S_n and hole Seebeck coefficient S_p can be calculated by:

$$S_{n} = \mathsf{m}\frac{k_{B}}{e} \left(\frac{(\lambda+2)F_{\lambda+1}(\eta)}{(\lambda+1)F_{\lambda}(\eta)} - \eta \right)$$
(S6)

$$S_{\rm p} = \mathsf{m} \frac{k_B}{e} \left(\frac{(\lambda + 2)F_{\lambda+1}(-\eta - E_{\rm g})}{(\lambda + 1)F_{\lambda}(-\eta - E_{\rm g})} + \eta + E_{\rm g} \right)$$
(S7)

The electron conductivity σ_n and hole conductivity σ_p can be estimated by Equations S8–S10:

$$\sigma_{\rm n} = n_0 \mu_{\rm aver} e \tag{S8}$$

$$\sigma_{\rm h} = A p_0 \mu_{\rm aver} e \tag{S9}$$

$$\sigma_{\rm n}S_{\rm n} + \sigma_{\rm p}S_{\rm p} = \sigma S \tag{S10}$$

where μ_{aver} is average mobility, and A is a parameter to fit calculated Seebeck coefficient and measured Seebeck coefficient. Finally, bipolar thermal conductivity can be calculated by¹:

$$\kappa_{\text{bipolar}} = \frac{\sigma_{\text{n}}\sigma_{\text{p}}}{\sigma_{\text{n}} + \sigma_{\text{p}}} \left(S_{\text{n}} - S_{\text{p}}\right)^2 T$$
(S11)

B: Calculation of the Mg content

It is assumed that each Bi_{Sn} introduces one electron and each V_{Mg} introduces two holes. Then, the content of Mg vacancies can be estimated by²:

$$x_{\rm V} = \frac{1}{2} \left(x - \Delta n \frac{M}{\rho N_{\rm A}} \right) \tag{S12}$$

$$\Delta n = n - n_0 \tag{S13}$$

where x_v is the content of V_{Mg} , x is the nominal Bi content, n is the measured carrier concentration for our Mg_{2- δ}Si_{0.12}Ge_{0.13}Sn_{0.75-x}Bi_x samples, n_0 is the carrier concentration of Mg₂Si_{0.12}Ge_{0.13}Sn_{0.75}, M is the relative molecular mass, ρ is the sample's density, and N_A is the Avogadro constant. Therefore, the content of Mg (x_{Mg}) is given by

$$x_{\rm Mg} = 2 - x_{\rm V}$$
 (S14)



Fig. S1. Phase diagram of Mg₂Si-Mg₂Ge-Mg₂Sn-Mg₃Bi₂ quaternary system. The black sphere symbols represent the data from references³⁻¹⁰, while the blue sphere symbols represent the samples synthesized in this work.



Fig. S2. Backscattered electron microscopy (BSE) images and corresponding elemental energy-dispersive X-ray spectroscopy (EDS) mapping of $Mg_{2-\partial}Si_{0.12}Ge_{0.13}Sn_{0.75-x}Bi_x$ (x = 0.02, 0.15)



Fig. S3. Observed (red) and calculated (black) diffraction patterns and difference profiles (pink) for samples $Mg_{2-\delta}Si_{0.12}Ge_{0.13}Sn_{0.75-x}Bi_x$ (*x*=0, 0.01, 0.02, 0.03, 0.05, 0.08, 0.10, 0.15) at room temperature.



Fig. S4. Lattice parameter as a function of Bi content *x*.



Fig. S5. Structure factor *S* as a function of *Q*.



Fig. S6. Molecular dynamics simulations of the trajectory of Mg, Si, Ge, Sn, Bi at 400 K, 600 K, and 700 K



Fig. S7. Crystal structure of different supercells. (a) S1 ($2 \times 2 \times 2$ supercell), (b) S2 ($2 \times 2 \times 2$ supercell), (c) S3 ($2 \times 2 \times 2$ supercell), and (d) S4 ($3 \times 3 \times 2$ supercell).



Fig. S8. Total energy *E* as a function of stimulation time *t* for different supercells. (a) S1 (2×2×2 supercell), (b) S2 (2×2×2 supercell), (c) S3 (2×2×2 supercell), and (d) S4 (3×3×2 supercell).



Fig. S9. Calculated bond length for different supercells. (a) S1 (2×2×2 supercell), (b) S2 (2×2×2 supercell), (c) S3 (2×2×2 supercell), and (d) S4 (3×3×2 supercell).



Fig. S10. Calculated IpCOHP for different supercells. (a) S1 (2×2×2 supercell), (b) S2 (2×2×2 supercell), (c) S3 (2×2×2 supercell), and (d) S4 (3×3×2 supercell).



Fig. S11. Calculated (a) MSD at 300 K and (b) mixing enthalpy ΔH for different supercells.



Fig. S12. The obtained crystal structures of $Mg_2Si_4Ge_4Sn_{20}Bi_4$: (a) volume relaxation with fixed atomic positions within the cubic lattice, (b) full relaxation with the cell volume, shape and atomic positions optimized.



Fig. S13. Lattice thermal conductivity κ_L at 300 K as a function of Bi content *x*. The dashed line denotes the calculated κ_L by the Callaway model.



Fig. S14. Temperature dependence of (a) electrical conductivity σ , (b) Seebeck coefficient *S*, (c) power factor *PF*, (d) thermal conductivity κ , (e)lattice thermal conductivity $\kappa_{\rm L}$ and (d) *zT* of sample Mg_{2- δ}Si_{0.12}Ge_{0.13}Sn_{0.73}Bi_{0.02} after three cycles and after quenching at 800 K.



Fig. S15. Backscattered electron microscopy (BSE) images and corresponding elemental energy-dispersive X-ray spectroscopy (EDS) mapping of Mg_{2- δ}Si_{0.12}Ge_{0.13}Sn_{0.73}Bi_{0.02}. (a) after three cycles; (b) after quenching.



Fig. S16. Temperature dependence of (a) electrical conductivity σ , (b) Seebeck coefficient *S*, (c) power factor *PF*, (d) thermal conductivity κ , (e)lattice thermal conductivity $\kappa_{\rm L}$ and (d) *zT* of sample Mg_{2- δ}Si_{0.12}Ge_{0.13}Sn_{0.55}Bi_{0.20} after three cycles and after quenching at 800 K.



Fig. S17. Backscattered electron microscopy (BSE) images and corresponding elemental energy-dispersive X-ray spectroscopy (EDS) mapping of Mg_{2-} $_{\delta}Si_{0.12}Ge_{0.13}Sn_{0.55}Bi_{0.20}$ (a) after three cycles; (b) after quenching.



Fig. S18. Calculated Mg content as a function of Bi content x

Table S1. Atomic radius, electronegativity, and the most likely valence state of Mg, Si,Ge, Sn and Bi in $Mg_{2-\partial}Si_{0.12}Ge_{0.132}Sn_{0.748-x}Bi_x$.

Atom	Atomic radius (Å)	Electronegativity	Valence state
Mg	1.50	1.31	+2
Si	1.10	1.90	-4
Ge	1.25	2.01	-4
Sn	1.45	1.96	-4
Bi	1.60	2.02	-3

Table S2. Rietveld refined results of samples $Mg_{2-\delta}Si_{0.12}Ge_{0.13}Sn_{0.75-x}Bi_x$

Composition	Atom	X	у	Z	Occ.	Uiso	Site	Sym.
<i>x</i> =0	Mg	0.25	0.75	0.75	0.994	0.014	8c	-43m
	Si	0	0	0	0.120	0.006	4a	m-3m
	Ge	0	0	0	0.130	0.006	4a	m-3m
	Sn	0	0	0	0.750	0.006	4a	m-3m
	Mg	0.25	0.75	0.75	1.000	0.011	8c	-43m
	Si	0	0	0	0.120	0.002	4a	m-3m
<i>x</i> =0.01	Ge	0	0	0	0.130	0.002	4a	m-3m
	Sn	0	0	0	0.740	0.002	4a	m-3m
	Bi	0	0	0	0.010	0.002	4a	m-3m
	Mg	0.25	0.75	0.75	0.981	0.014	8c	-43m
	Si	0	0	0	0.120	0.006	4a	m-3m
<i>x</i> =0.02	Ge	0	0	0	0.130	0.006	4a	m-3m
	Sn	0	0	0	0.730	0.006	4a	m-3m
	Bi	0	0	0	0.020	0.006	4a	m-3m
	Mg	0.25	0.75	0.75	0.983	0.014	8c	-43m
	Si	0	0	0	0.120	0.005	4a	m-3m
<i>x</i> =0.03	Ge	0	0	0	0.130	0.005	4a	m-3m
	Sn	0	0	0	0.720	0.005	4a	m-3m
	Bi	0	0	0	0.030	0.005	4a	m-3m
<i>x</i> =0.05	Mg	0.25	0.75	0.75	0.973	0.014	8c	-43m
	Si	0	0	0	0.120	0.005	4a	m-3m

	Ge	0	0	0	0.130	0.005	4a	m-3m
	Sn	0	0	0	0.700	0.005	4a	m-3m
	Bi	0	0	0	0.050	0.005	4a	m-3m
	Mg	0.25	0.75	0.75	1.000	0.016	8c	-43m
	Si	0	0	0	0.120	0.007	4a	m-3m
<i>x</i> =0.08	Ge	0	0	0	0.130	0.007	4a	m-3m
	Sn	0	0	0	0.670	0.007	4a	m-3m
	Bi	0	0	0	0.080	0.007	4a	m-3m
	Mg	0.25	0.75	0.75	0.961	0.020	8c	-43m
	Si	0	0	0	0.120	0.014	4a	m-3m
<i>x</i> =0.10	Ge	0	0	0	0.130	0.014	4a	m-3m
	Sn	0	0	0	0.650	0.014	4a	m-3m
	Bi	0	0	0	0.100	0.014	4a	m-3m
	Mg	0.25	0.75	0.75	0.956	0.024	8c	-43m
	Si	0	0	0	0.120	0.017	4a	m-3m
<i>x</i> =0.15	Ge	0	0	0	0.130	0.017	4a	m-3m
	Sn	0	0	0	0.600	0.017	4a	m-3m
	Bi	0	0	0	0.150	0.017	4a	m-3m
	Mg	0.25	0.75	0.75	1.000	0.021	8c	-43m
<i>x</i> =0.20	Si	0	0	0	0.120	0.009	4a	m-3m
	Ge	0	0	0	0.130	0.009	4a	m-3m
	Sn	0	0	0	0.550	0.009	4a	m-3m

Composition	R _p	wR _p	R _{obs}	wR _{obs}	R _{all}	wR _{all}
<i>x</i> =0	4.63%	6.30%	1.51%	2.40%	1.51%	2.40%
<i>x</i> =0.01	5.04%	6.93%	1.52%	2.01%	1.52%	2.01%
<i>x</i> =0.02	5.09%	6.58%	1.49%	2.24%	1.49%	2.24%
<i>x</i> =0.03	3.64%	5.17%	1.20%	1.87%	1.20%	1.87%
<i>x</i> =0.05	5.10%	6.45%	1.45%	2.23%	1.45%	2.23%
<i>x</i> =0.08	4.16%	5.98%	1.19%	1.82%	1.19%	1.82%
<i>x</i> =0.10	6.97%	8.78%	1.29%	2.53%	1.29%	2.53%
<i>x</i> =0.15	6.13%	7.75%	1.11%	2.15%	1.11%	2.15%
<i>x</i> =0.20	5.26%	7.26%	1.33%	2.24%	1.33%	2.24%

 Table S3. Quality factor of Rietveld refinement.

Table S4. ADP and error of samples $Mg_{2-\delta}Si_{0.12}Ge_{0.13}Sn_{0.75-x}Bi_x$.

Composition	Mg U _{iso} (Å ²)	Error (Ų)	X U _{iso} (Å ²)	Error (Ų)
<i>x</i> =0	0.0144	4×10 ⁻⁴	0.006	1.2×10 ⁻⁴
<i>x</i> =0.01	0.015	4×10 ⁻⁴	0.007	1.2×10 ⁻⁴
<i>x</i> =0.02	0.0138	4×10-4	0.00634	1.3×10-4

<i>x</i> =0.03	0.014	3×10-4	0.00541	9×10-5
<i>x</i> =0.05	0.0138	4×10 ⁻⁴	0.00526	1.4×10 ⁻⁴
<i>x</i> =0.08	0.016	2×10 ⁻⁴	0.0073	1×10 ⁻⁴
<i>x</i> =0.10	0.0202	9×10 ⁻⁴	0.0137	8×10-4
<i>x</i> =0.15	0.0236	7×10 ⁻⁴	0.0168	6×10 ⁻⁴

Table S5. PDF fits results of samples $Mg_{2-\delta}Si_{0.12}Ge_{0.13}Sn_{0.65}Bi_{0.10}$.

Structure	Atom	X	У	Z	Occ.	$U_{ m iso}$	Site	Sym.
	Mg1	0.234	0.766	0.766	0.960	3.520	la	1
	Mg2	0.765	0.234	0.766	0.960	3.520	la	1
	Mg3	0.765	0.766	0.234	0.960	3.520	la	1
	Mg4	0.234	0.234	0.234	0.960	3.520	la	1
Broken	Mg5	0.765	0.234	0.234	0.960	3.520	la	1
symmetry	Mg6	0.234	0.766	0.234	0.960	3.520	la	1
model	Mg7	0.765	0.766	0.766	0.960	3.520	la	1
	Mg8	0.234	0.234	0.766	0.960	3.520	la	1
	Si	0	0	0	0.120	2.180	4a	m-3m
	Ge	0	0	0	0.130	2.180	4a	m-3m
	Sn	0	0	0	0.650	2.180	4a	m-3m
	Bi	0	0	0	0.100	2.180	4a	m-3m
	Mg	0.25	0.75	0.75	0.961	0.045	8c	-43m

Si	0	0	0	0.120	0.021	4a	m-3m
Ge	0	0	0	0.130	0.021	4a	m-3m
Sn	0	0	0	0.650	0.021	4a	m-3m
Bi	0	0	0	0.100	0.021	4a	m-3m

Table S6. The atomic radius, ionic radius, and orbital energy of Mg, Si, Ge, Sn and Bi.

Elements	Atomic radius (Å)	Ionic radius (Å)	Orbital energy
Mg	1.50	0.86	-7.65 eV (s orbital)
Si	1.10	0.54	-7.78 eV (p orbital)
Ge	1.25	0.67	-7.54 eV (p orbital)
Sn	1.45	0.83	-7.01 eV (p orbital)
Bi	1.60	1.17	-8.15 eV (p orbital)

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